

TIL153, TIL154, TIL155 OPTOCOUPERS

electrical characteristics at 25° C free-air temperature

PARAMETER		TEST CONDITIONS	TIL153			TIL154			TIL155			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage	$I_C = 10 \mu A, I_E = 0, I_F = 0$	70			70			70			V
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage	$I_C = 1 mA, I_B = 0, I_F = 0$	30			30			30			V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0, I_F = 0$	7			7			7			V
I_R	Input Diode Static Reverse Current	$V_R = 3 V$			10			10			10	μA
$I_{C(on)}$	On-State Collector Current	Phototransistor Operation $V_{CE} = 10 V, I_B = 0, I_F = 10 mA$	1	3		2	5		5	9		mA
	Photodiode Operation	$V_{CB} = 10 V, I_E = 0, I_F = 10 mA$		10			10			10		μA
$I_{C(off)}$	Off-State Collector Current	Phototransistor Operation $V_{CE} = 10 V, I_B = 0, I_F = 0$		1	50		1	50		1	50	nA
	Photodiode Operation	$V_{CB} = 10 V, I_E = 0, I_F = 0$		0.1	20		0.1	20		0.1	20	
h_{FE}	Transistor Static Forward Current Transfer Ratio	$V_{CE} = 5 V, I_C = 10 mA, I_F = 0$	50	100		100	200		100	550		
V_F	Input Diode Static Forward Voltage	$I_F = 10 mA$	1.2	1.4		1.2	1.4		1.2	1.4		V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 1 mA, I_B = 0, I_F = 10 mA$	0.25	0.4		0.25	0.4		0.25	0.4		V
r_{iO}	Input-to-Output Internal Resistance	$V_{in-out} = 500 V,$ See Note 5	10^{11}			10^{11}			10^{11}			Ω
C_{iO}	Input-to-Output Capacitance	$V_{in-out} = 0, f = 1 MHz,$ See Note 5	1	1.3		1	1.3		1	1.3		pF

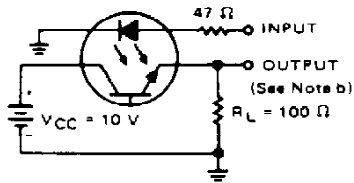
NOTE 5: These parameters are measured between both input diode leads shorted together and all the phototransistor leads shorted together.

switching characteristics at 25° C free-air temperature

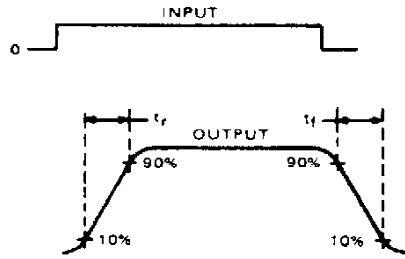
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_r	Rise Time	Phototransistor Operation $V_{CC} = 10 V, I_{C(on)} = 2 mA, R_L = 100 \Omega,$ See Test Circuit A of Figure 1		5	10	μs
t_f	Fall Time			5	10	
t_r	Rise Time	Photodiode Operation $V_{CC} = 10 V, I_{C(on)} = 20 \mu A, R_L = 1 k\Omega,$ See Test Circuit B of Figure 1		1		μs
t_f	Fall Time			1		

PARAMETER MEASUREMENT INFORMATION

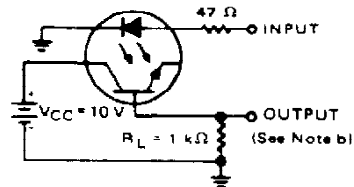
Adjust amplitude of input pulse for:
 $I_{C(on)} = 2 \text{ mA}$ (Test Circuit A) or
 $I_{C(on)} = 20 \mu\text{A}$ (Test Circuit B)



TEST CIRCUIT A
PHOTOTRANSISTOR OPERATION



VOLTAGE WAVEFORMS



TEST CIRCUIT B
PHOTODIODE OPERATION

NOTES: a. The input waveform is supplied by a generator with the following characteristics: $Z_{out} = 50 \Omega$, $t_r \leq 15 \text{ ns}$, duty cycle $\approx 1\%$, $t_w = 100 \mu\text{s}$.
 b. The output waveform is monitored on an oscilloscope with the following characteristics: $t_r \leq 12 \text{ ns}$, $R_{in} \geq 1 \text{ M}\Omega$, $C_{in} \leq 20 \text{ pF}$.

FIGURE 1—SWITCHING TIMES

TYPICAL CHARACTERISTICS

COLLECTOR CURRENT
 VS
 INPUT-DIODE FORWARD CURRENT

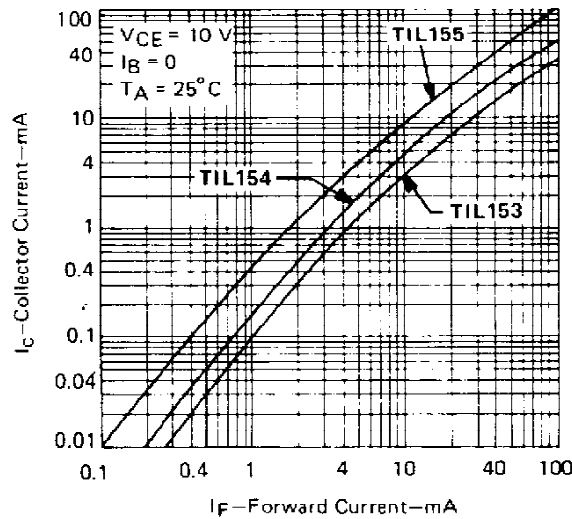
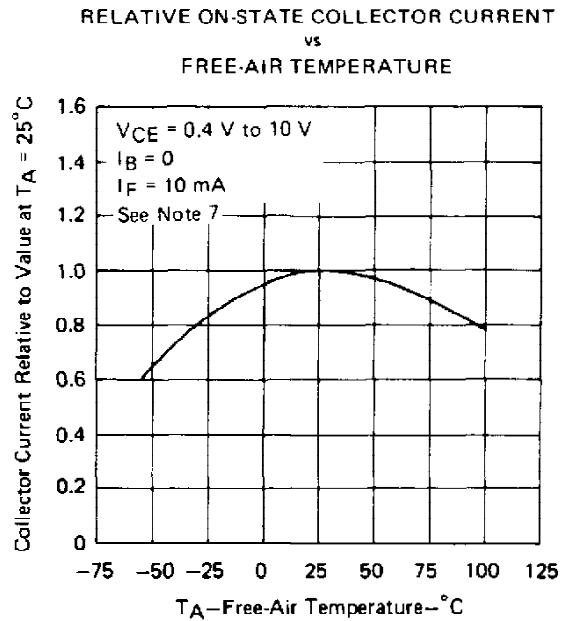
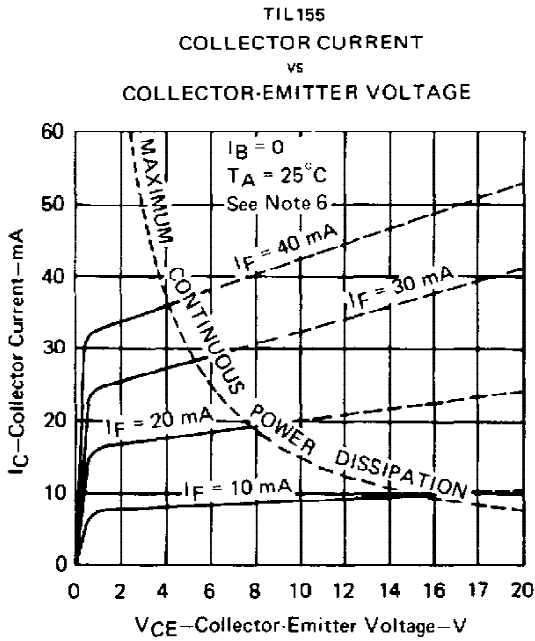
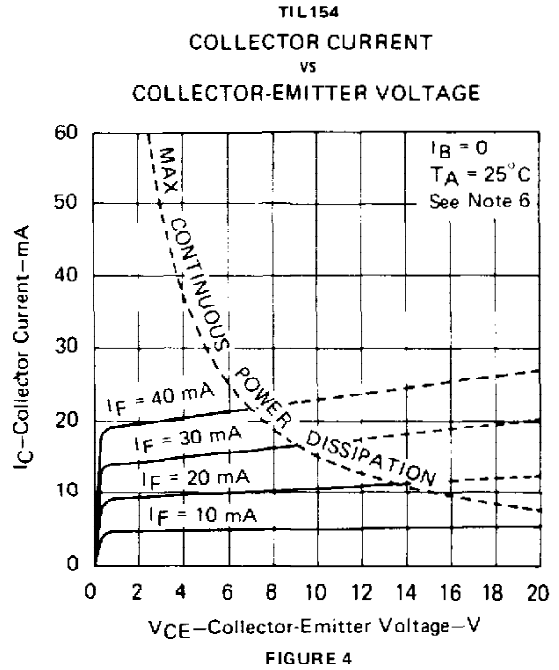
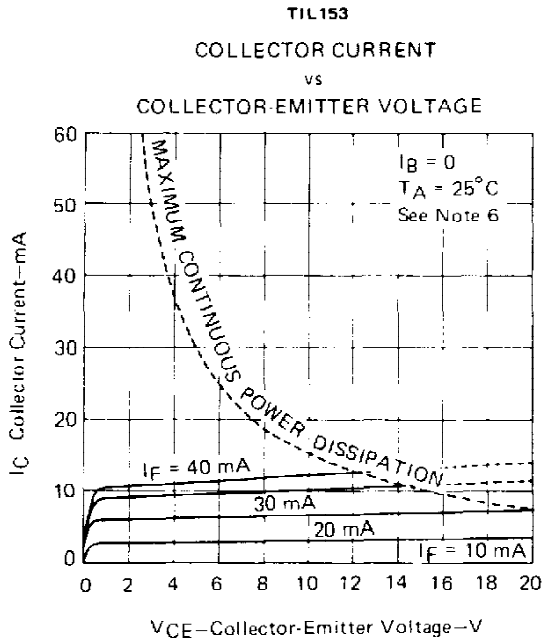


FIGURE 2

**TIL153, TIL154, TIL155
OPTOCOUPERS**

TYPICAL CHARACTERISTICS



NOTES: 6. Pulse operation of input diode is required for operation beyond limits shown by dotted lines.
7. These parameters were measured using pulse techniques. $t_w = 1$ ms, duty cycle $\leq 2\%$.

TYPICAL CHARACTERISTICS

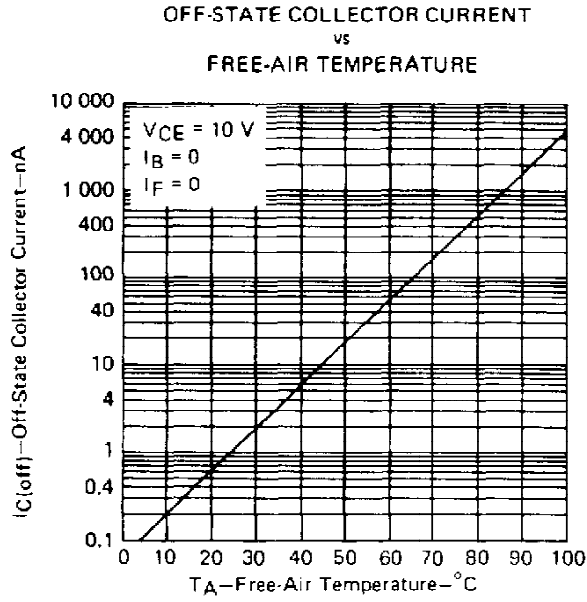


FIGURE 7

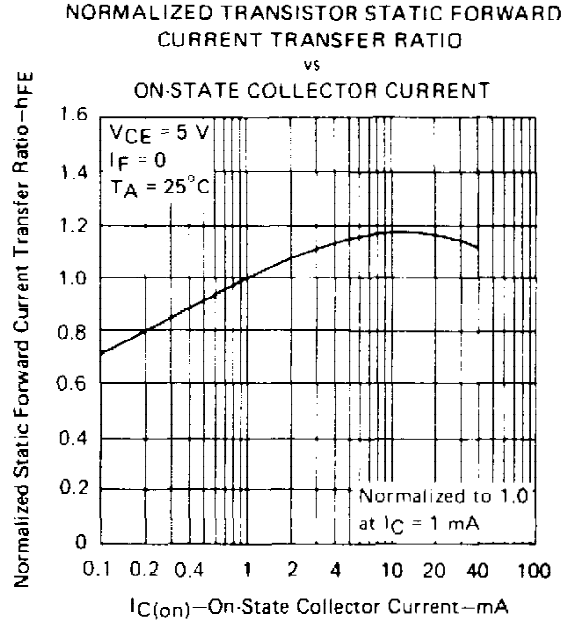


FIGURE 8

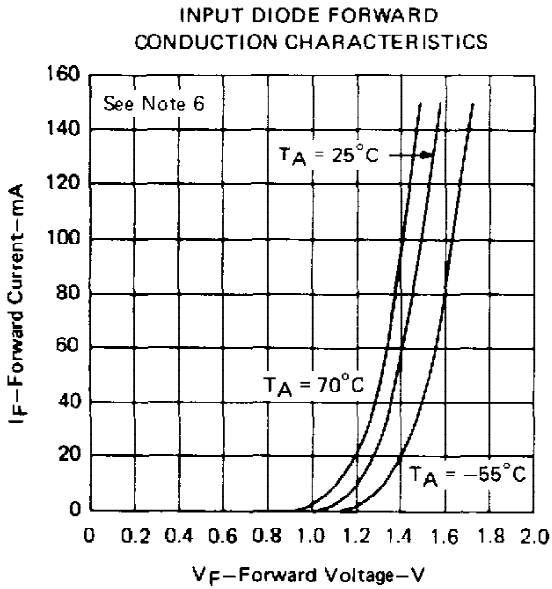


FIGURE 9

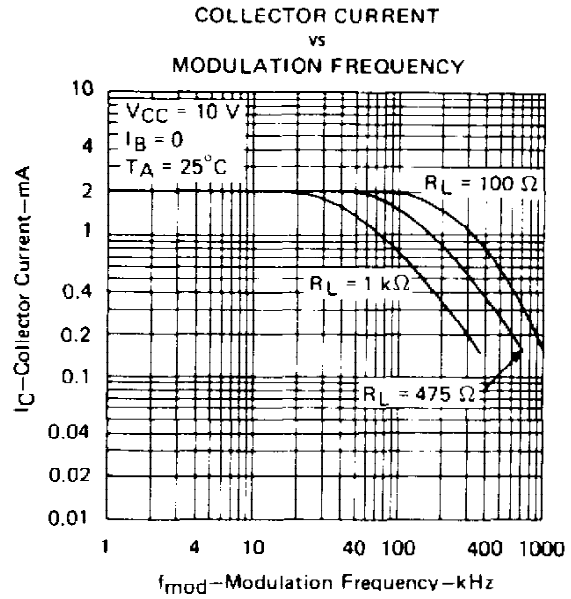


FIGURE 10

NOTE 6: These parameters were measured using pulse techniques. $t_w = 1\text{ ms}$, duty cycle $< 2\%$

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Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TIL153	OBSOLETE	PDIP	N	6		TBD	Call TI	Call TI
TIL154	OBSOLETE	PDIP	N	6		TBD	Call TI	Call TI
TIL155	OBSOLETE	PDIP	N	6		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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